

## ABSTRACT

The invention relates to a light-emitting arrangement, having: - at least one light-emitting diode chip (1), - a  
5 multi-layer board (17) having a base (5) of a thermally well conducting material, in particular of metal, and - an electrical insulating and thermally conducting connection layer (2) between the emission surface of the light-diode chip (1) and the board (17).